



PKG. CODES
[S8-2 / S8+2]
[S8-4 / S8+4]
[S8-5 / S8+5]
[S8M-5 / S8M+5]
[S8-6F / S8+6F]
[S8-7F / S8+7F]
[S8-8F / S8+8F]
[S8-10F / S8+10F]
[S8-11F / S8+11F]
[S8-15 / S8+15]
[S8-16F / S8+16F]
[S8MK-1 / S8MK+1]
[S8+19F]

NOTES:

1. REFERENCE PKG. OUTLINE: 21-0041.
2. LAND PATTERN COMPLIES TO: IPC7351A.
3. TOLERANCE: ± 0.02 MM.
4. ALL DIMENSIONS APPLY TO BOTH LEADED (-) AND PbfREE (+) PKG. CODES.
5. ALL DIMENSIONS ARE IN MM.

—DRAWING NOT TO SCALE—



This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depend on many factors unknown to Maxim (eg. user's board manufacturing specs), user must determine suitability for use. This document is subject to change without notice. Contact technical support at <http://www.maxim-ic.com/support> for further questions.

TITLE: PACKAGE LAND PATTERN, [S8] 0.150" SOIC, 8 LEADS			
APPROVAL	DOCUMENT CONTROL NO. 90-0096	REV. D	1/1

REVISION HISTORY

REV	CHANGES MADE	DATE	ORIGINATOR
A	ECN #DS-09-0118 Initial release	04/08/09	GP
B	ECN #DS-09-0563 S8-13/S8+13 PKG. CODE REMOVED FROM TABLE. PKGCODE HAS BEEN OBSOLETEED.	09/30/09	GP
C	ECN #DS-11-2284 S8MK-1 / +1 PKG. CODE ADDED	07/25/11	GP
D	ECN# DS-13-0970 - Add new package code S8+19F.	10/15/13	AG

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	DOCUMENT I.D. 90-0096	REVISION D	PAGE 2